



PATENT
ATTY. DOCKET NO.: P67426US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Joon Ki HONG

Group Art Unit: 2814

Serial No.: 10/017,318

Examiner: Nathan Ha

Filed: December 18, 2001

For: STACK CHIP MODULE WITH ELECTRICAL CONNECTION AND ADHESION OF
CHIPS THROUGH A BUMP FOR IMPROVED HEAT RELEASE CAPACITY
(As Amended)

AMENDMENT UNDER RULE 1.116

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Final Office Action (Paper No. 9) dated July 21, 2003, kindly
amend the above-identified patent application as set forth herein.

